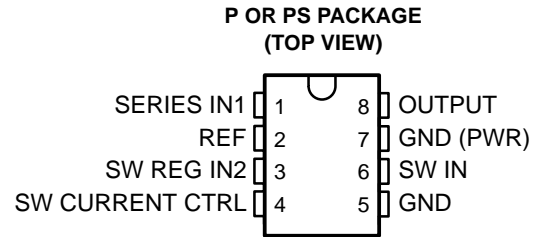


TL499A WIDE-RANGE POWER-SUPPLY CONTROLLERS

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- Internal Series-Pass and Step-Up Switching Regulator
- Output Adjustable From 2.9 V to 30 V
- 1-V to 10-V Input for Switching Regulator
- 4.5-V to 32-V Input for Series Regulator
- Externally Controlled Switching Current
- No External Rectifier Required



description

The TL499A is an integrated circuit designed to provide a wide range of adjustable regulated supply voltages. The regulated output voltage can be varied from 2.9 V to 30 V by adjusting two external resistors. When the TL499A is ac-coupled to line power through a step-down transformer, it operates as a series dc voltage regulator to maintain the regulated output voltage. With the addition of a battery from 1.1 V to 10 V, an inductor, a filter capacitor, and two resistors, the TL499A operates as a step-up switching regulator during an ac-line failure.

The adjustable regulated output voltage makes the TL499A useful for a wide range of applications. Providing backup power during an ac-line failure makes the TL499A extremely useful in microprocessor memory applications.

The TL499AC is characterized for operation from -20°C to 85°C .

AVAILABLE OPTIONS

T_A	PLASTIC DIP (P)	PLASTIC SMALL-OUTLINE (PS)
-20°C to 85°C	TL499ACP	TL499ACPS

The PS package is available taped and reeled. Add the suffix R to device type (e.g., TL499ACPSR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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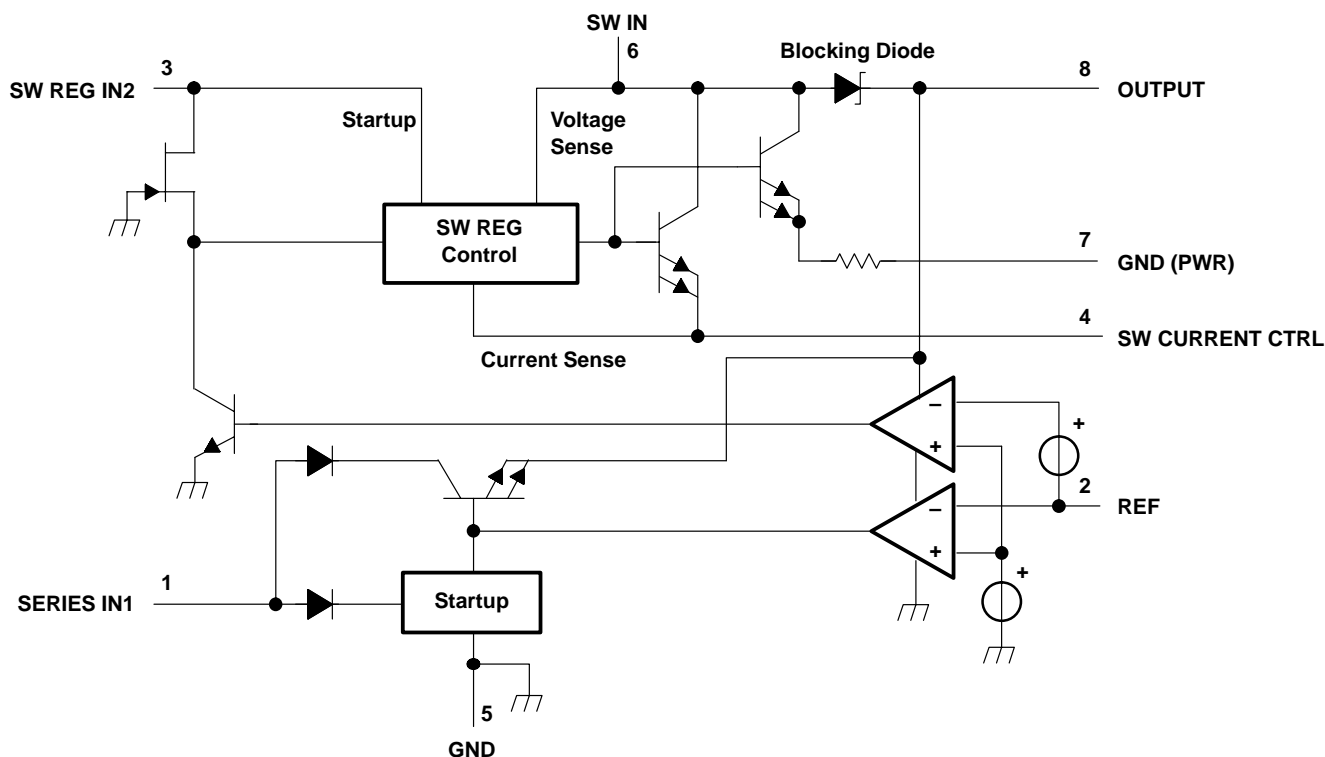
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functional block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Output voltage, V_O (see Note 1)	35 V
Input voltage, series regulator, V_{I1}	35 V
Input voltage, switching regulator, V_{I2}	10 V
Blocking-diode reverse voltage	35 V
Blocking-diode forward current	1 A
Power switch current (SW IN)	1 A
Package thermal impedance, θ_{JA} (see Notes 2 and 3): P package	85°C/W
PS package	95°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T_{stg}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values are with respect to network ground terminal.
 2. Maximum power dissipation is a function of $T_J(\max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions

	MIN	NOM	MAX	UNIT
Output voltage, V_O	2.9		30	V
Input voltage, V_{I1} (SERIES IN1)	4.5		32	V
Input voltage, V_{I2} (SW REG IN2)	1.1		10	V
Output-to-input differential voltage, switching regulator, $V_O - V_{I2}$ (see Note 4)	1.2		28.9	V
Continuous output current, I_O			100	mA
Power switch current (at SW IN)			500	mA
Current-limiting resistor, R_{CL}	150		1000	Ω
Filter capacitor	100		470	μ F
Pass capacitor		0.1		μ F
Inductor, L (dcr $\leq 0.1 \Omega$)	50		150	μ H
Operating free-air temperature, T_A	-20		85	$^{\circ}$ C

NOTE 4: When operating temperature range is $T_A \leq 70^{\circ}\text{C}$, minimum $V_O - V_{I2}$ is ≥ 1.2 V. When operating temperature range is $T_A \leq 85^{\circ}\text{C}$, minimum $V_O - V_{I2}$ is ≥ 1.9 V.

electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	TL499AC			UNIT
			MIN	TYP	MAX	
Voltage deviation (see Note 5)				20	30	mV/V
$V_O - V_{I2}$	Switching regulator	$T_A = -20^{\circ}\text{C}$ to 70°C	1.2			V
		$T_A = -20^{\circ}\text{C}$ to 85°C	1.9			
Dropout voltage	Series regulator	$V_{I1} = 15$ V, $I_O = 50$ mA			1.8	
Reference voltage (internal)		$V_{I1} = 5$ V, $V_O = 3$ V, $I_O = 1$ mA	1.2	1.26	1.32	V
Reference-voltage change with temperature				5	10	mV/V
Output regulation (of reference voltage)		$I_O = 1$ mA to 50 mA		10	30	mV/V
Output current (see Figure 1)	Switching regulator	$V_{I2} = 1.1$ V, $V_O = 12$ V, $R_{CL} = 150 \Omega$, $T_A = 25^{\circ}\text{C}$			10	mA
		$V_{I2} = 1.5$ V, $V_O = 15$ V, $R_{CL} = 150 \Omega$, $T_A = 25^{\circ}\text{C}$			15	
		$V_{I2} = 6$ V, $V_O = 30$ V, $R_{CL} = 150 \Omega$, $T_A = 25^{\circ}\text{C}$			65	
	Series regulator				100	
Standby current	Switching regulator	$V_{I2} = 3$ V, $V_O = 9$ V, $T_A = 25^{\circ}\text{C}$		15	80	μ A
	Series regulator	$V_{I1} = 15$ V, $V_O = 9$ V, $R_{E2} = 4.7 \text{ k}\Omega$		0.8	1.2	mA

NOTE 5: Voltage deviation is the output voltage difference that occurs in a change from series regulation to switching regulation:
Voltage deviation = $V_O(\text{series regulation}) - V_O(\text{switching regulation})$



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APPLICATION INFORMATION

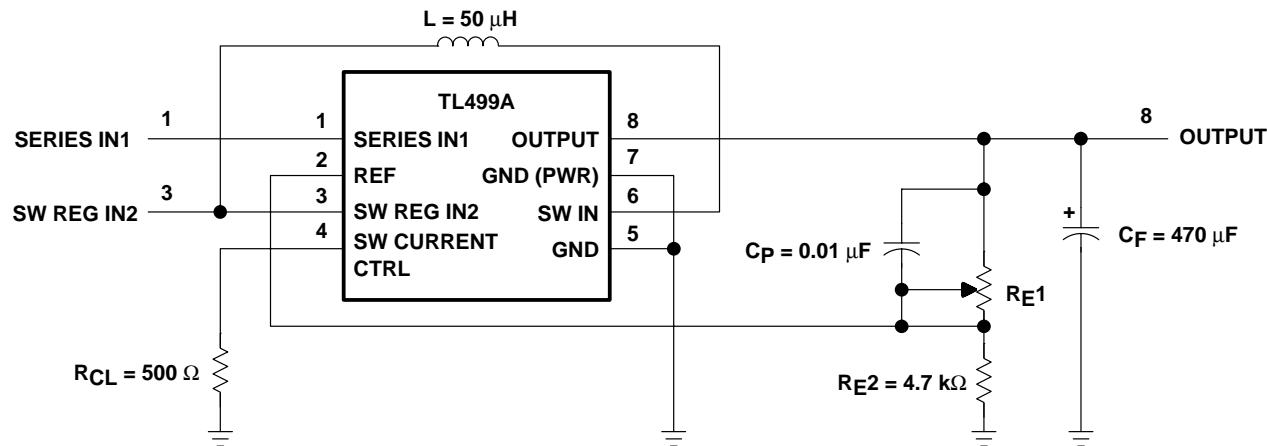


Figure 1. TL499A Basic Configuration

Table 1. Maximum Output Current vs Input and Output Voltages
for Step-Up Switching Regulator With $R_{CL} = 150 \, \Omega$

OUTPUT VOLTAGE (V)	SWITCHING REGULATOR INPUT VOLTAGE (SW REG IN2) (V)										
	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9
	OUTPUT CURRENT (mA)										
30										65	90
25									50	80	100
20						20	25	30	80	100	100
15				15	20	30	45	55	100	100	100
12	10	15	20	25	30	40	55	70	100	100	100
10	15	20	25	30	35	45	65	80	100	100	
9	20	25	25	35	40	50	70	90	100	100	
6	30	35	40	45	55	75	95	100			
5	35	40	45	55	70	85	100	100	Circuit of Figure 1, except: $R_{CL} = 150 \, \Omega$ $C_F = 330 \, \mu F$ $C_P = 0.1 \, \mu F$		
4.5	35	45	50	60	75	95	100	100†			
3	55	65†	75†	95†	100†						
2.9	60†	70†	75†	100†	100†						

† The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

APPLICATION INFORMATION

**Table 2. Maximum Output Current vs Input and Output Voltages
for Step-Up Switching Regulator With $R_{CL} = 200\ \Omega$**

OUTPUT VOLTAGE (V)	SWITCHING REGULATOR INPUT VOLTAGE (SW REG IN2) (V)										
	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9
	OUTPUT CURRENT (mA)										
30										50	100
25									50	70	100
20						15	25	30	70	90	100
15				10	15	25	35	45	90	100	100
12	10	10	15	20	25	35	45	60	100	100	100
10	15	20	20	25	30	40	55	70	100	100	
9	20	20	25	30	35	45	60	80	100		
6	25	30	35	45	50	65	90	100			
5	30	35	40	55	60	75	100	100	Circuit of Figure 1, except: $R_{CL} = 200\ \Omega$ $C_F = 330\ \mu F$ $C_P = 0.1\ \mu F$		
4.5	35	40	45	55	65	85	100	100†			
3	50	55†	65†	80†	90†						
2.9	50†	60†	65†	85†	100†						

† The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

**Table 3. Maximum Output Current vs Input and Output Voltages
for Step-Up Switching Regulator With $R_{CL} = 300\ \Omega$**

OUTPUT VOLTAGE (V)	SWITCHING REGULATOR INPUT VOLTAGE (SW REG IN2) (V)										
	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9
	OUTPUT CURRENT (mA)										
30										40	70
25									40	55	100
20						10	15	20	55	70	100
15				10	10	20	30	35	75	95	100
12	10	10	10	15	20	25	35	45	95	100	100
10	15	15	15	20	25	30	45	55	100	100	
9	15	15	20	25	30	35	50	60	100	100	
6	25	25	30	35	45	55	70	90			
5	30	30	35	45	50	65	85	100	Circuit of Figure 1, except: $R_{CL} = 300\ \Omega$ $C_F = 330\ \mu F$ $C_P = 0.1\ \mu F$		
4.5	30	35	40	45	55	70	95	100†			
3	45	50†	55†	70†	90†						
2.9	45†	50†	60†	75†	95†						

† The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

TL499A

WIDE-RANGE POWER-SUPPLY CONTROLLERS

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APPLICATION INFORMATION

**Table 4. Maximum Output Current vs Input and Output Voltages
for Step-Up Switching Regulator With $R_{CL} = 510 \Omega$**

OUTPUT VOLTAGE (V)	SWITCHING REGULATOR INPUT VOLTAGE (SW REG IN2) (V)										
	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9
	OUTPUT CURRENT (mA)										
30										30	50
25									25	40	75
20									40	55	90
15							15	20	55	70	100
12					10	15	25	35	65	80	100
10				10	20	25	30	40	70	85	
9	10	10	10	15	20	25	35	45	75	100	
6	15	20	20	25	30	35	50	60			
5	20	20	25	30	35	45	55	70	Circuit of Figure 1, except: $R_{CL} = 510 \Omega$ $C_F = 330 \mu F$ $C_P = 0.1 \mu F$		
4.5	20	25	30	35	40	50	65	90 [†]			
3	35	35 [†]	40 [†]	50 [†]	75 [†]						
2.9	35 [†]	35 [†]	40 [†]	55 [†]	80 [†]						

[†] The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

**Table 5. Maximum Output Current vs Input and Output Voltages
for Step-Up Switching Regulator With $R_{CL} = 1 k\Omega$**

OUTPUT VOLTAGE (V)	SWITCHING REGULATOR INPUT VOLTAGE (SW REG IN2) (V)										
	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9
	OUTPUT CURRENT (mA)										
30											35
25										35	50
20										35	60
15								10	30	45	65
12								20	40	45	85
10							15	25	40	55	
9				10	10	15	25	30	45	60	
6	10	10	10	15	20	20	30	35			
5	10	10	15	20	20	25	35	40	Circuit of Figure 1, except: $R_{CL} = 1 k\Omega$ $C_F = 330 \mu F$ $C_P = 0.1 \mu F$		
4.5	15	15	15	20	25	30	40	45 [†]			
3	20	25 [†]	25 [†]	30 [†]	35 [†]						
2.9	20 [†]	25 [†]	25 [†]	30 [†]	45 [†]						

[†] The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL499ACP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-20 to 85	TL499ACP	Samples
TL499ACPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	-20 to 85	TL499ACP	Samples
TL499ACPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-20 to 85	T499A	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

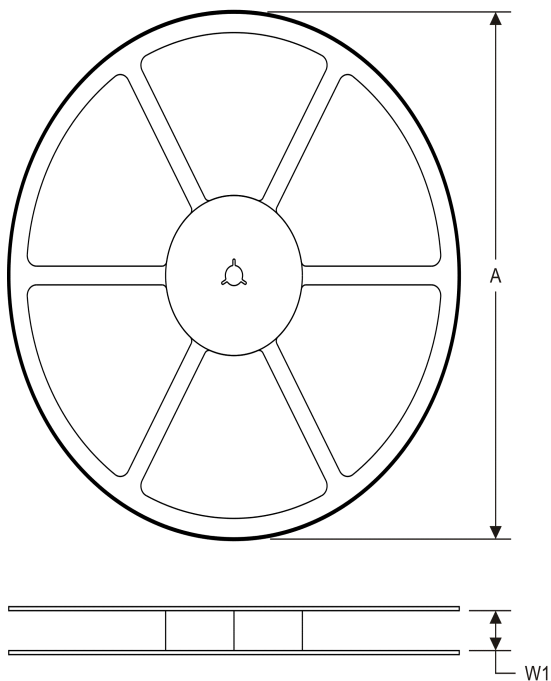
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL499ACPSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

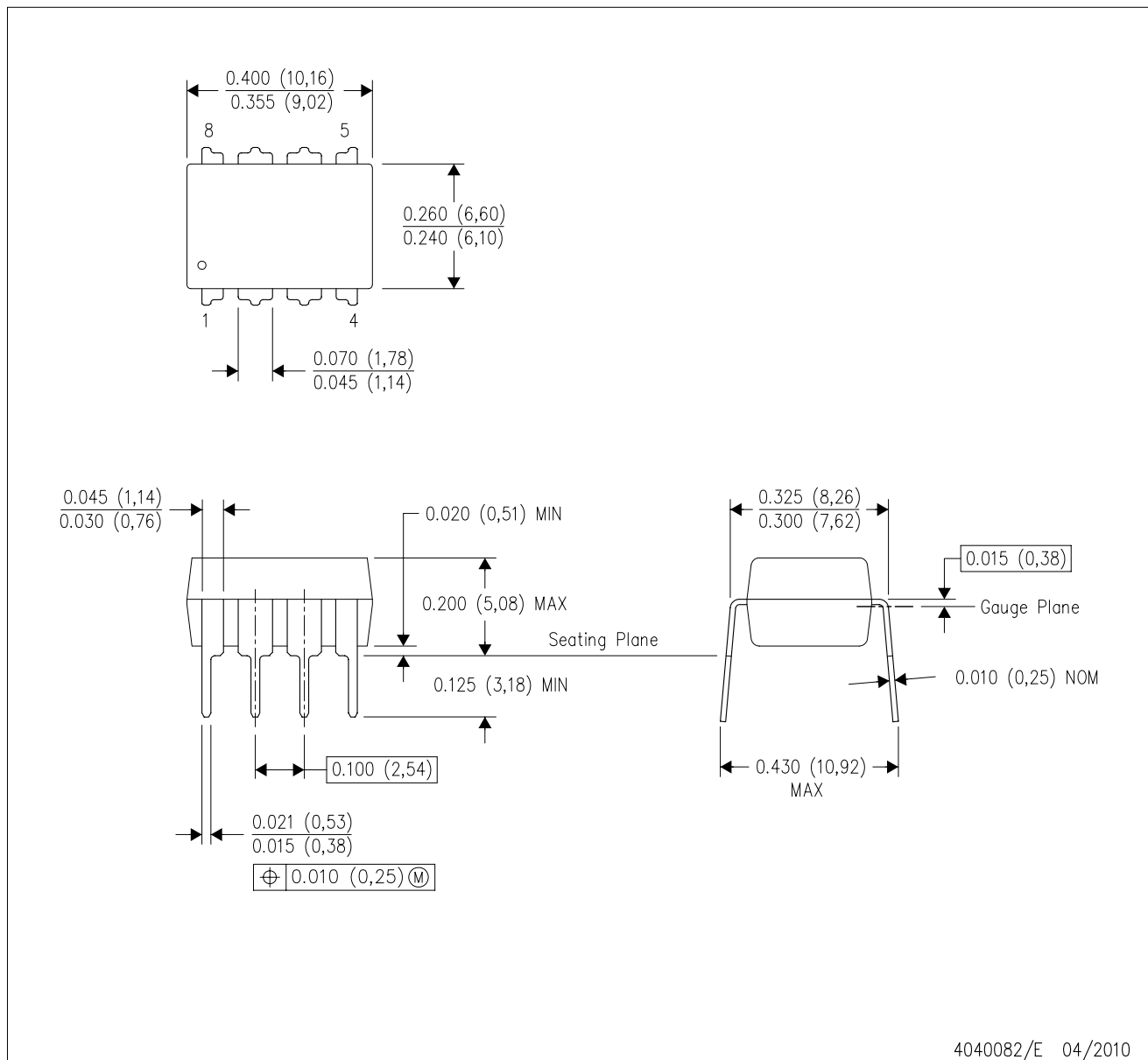


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL499ACPSR	SO	PS	8	2000	367.0	367.0	38.0

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4040063/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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